



Routes for Rapid Synthesis of Photovoltaic Absorber Materials: The Need for Diffusion Data

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Jevons Paradox

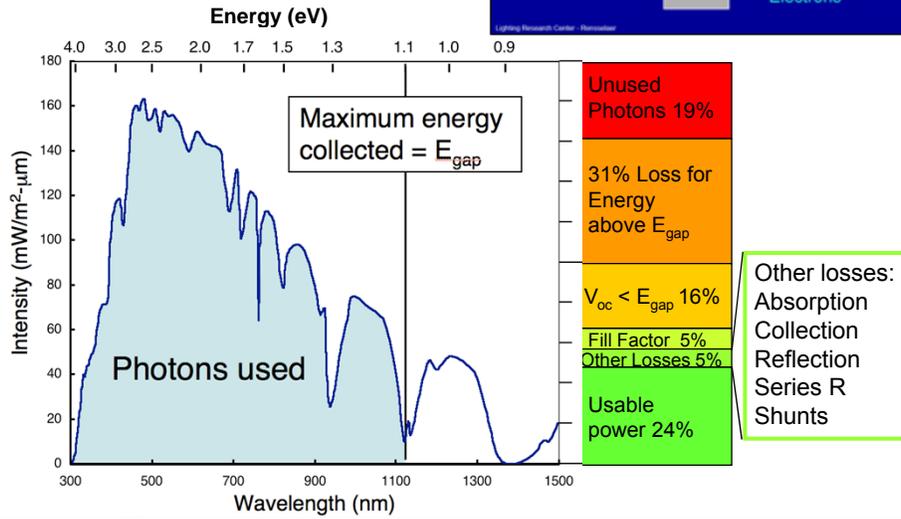
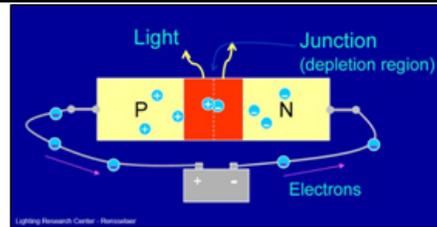
**Technological progress
that increases the
efficiency with which a
resource is used, tends to
increase (rather than
decrease) the rate of
consumption of that
resource.**



William Stanley Jevons

Simple Diode

Analysis for a 24%-efficient Si solar cell

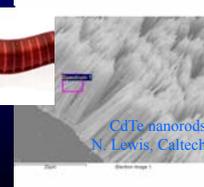


Photovoltaic Technologies

- **First generation**
 - Single crystal and multicrystalline Si
 - a-Si:H single junctions
- **Second generation**
 - Inorganic thin films (CuInSe₂ & CdTe)
 - Multijunction III-V & a-Si:H
- **Third generation**
 - Nanostructured & quantum dot PV
 - Photoelectrochemical cells
 - Organic photovoltaics
 - Intermediate band concepts

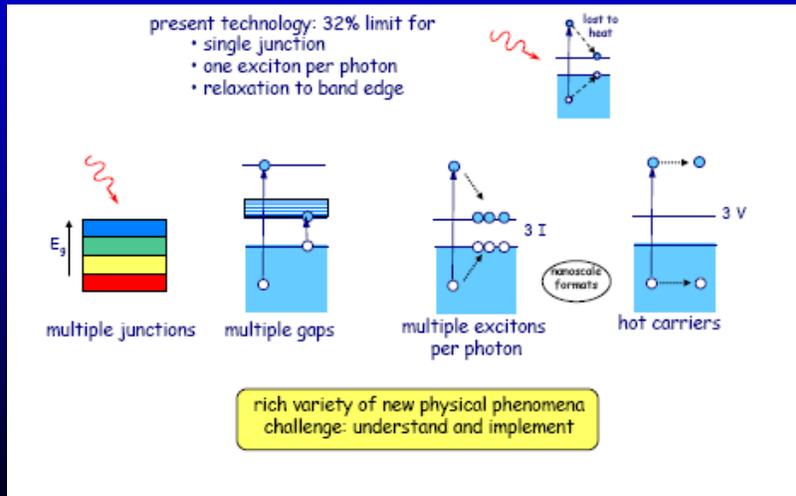


(PV-Tech.org)

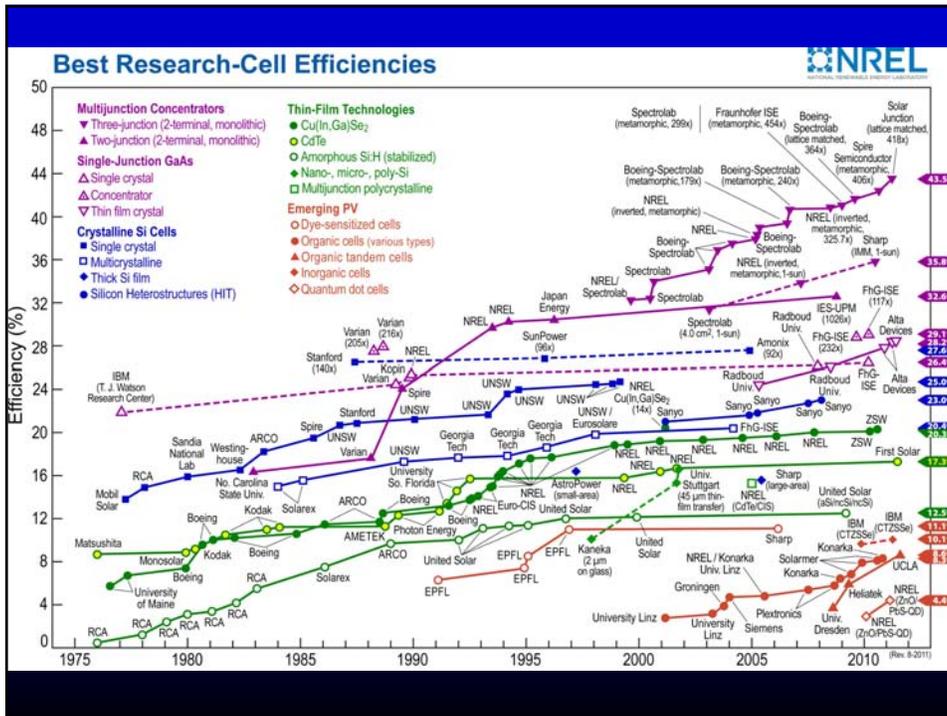




Routes to Increased Efficiency



www1.eere.energy.gov/solar/solar_america/pdfs/d_horwitz_os_bes.pdf

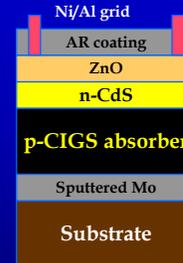




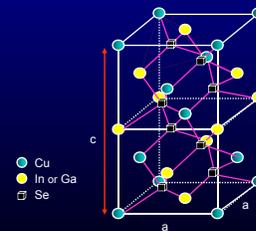
Cu(In_{1-x}Ga_x)Se₂ Solar Cells

Most Promising Thin Film Absorber Material

- Direct band gap (E_g ~ 1.2 eV)
- High optical absorption coefficient: ~ 2 μm
- High radiation resistance
- High reliability
- High conversion efficiency: cell: 20% and module: 13%
- Efficient in low-angle & low-light conditions
- Flexible substrates possible (BIPV, cheaper substrates?)
- Positive response under concentration



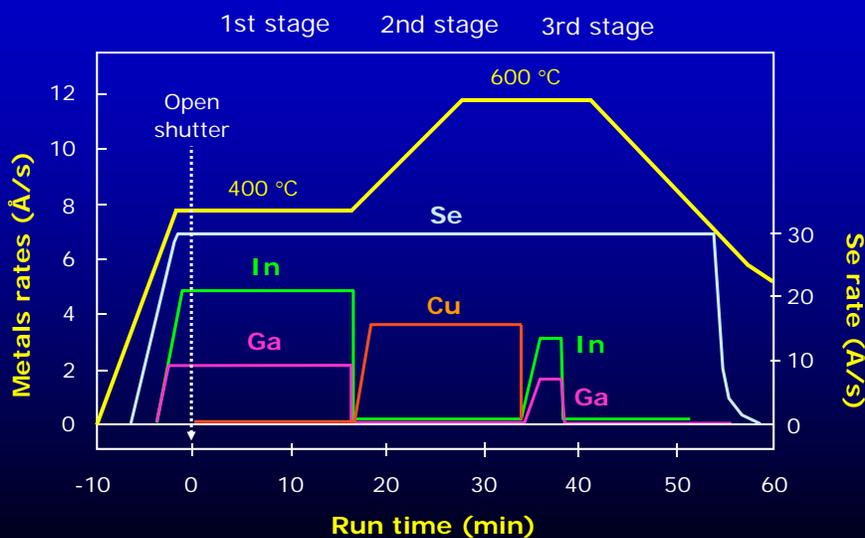
CIGS solar cell structure



Chalcopyrite structure



NREL 3-stage Process: Champion Cell

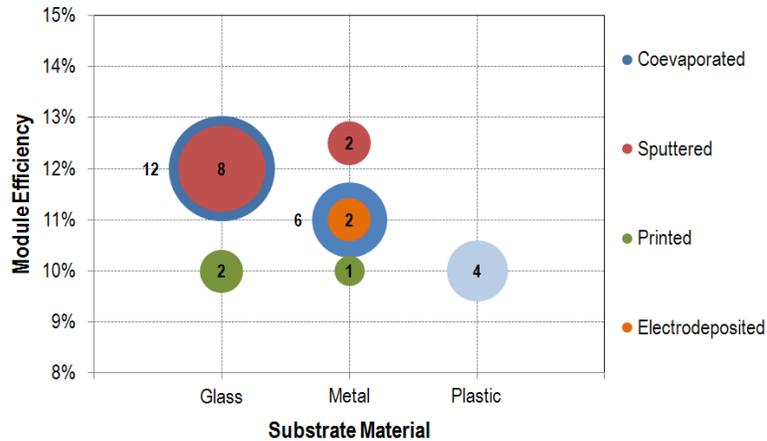




Approaches to CIGS Synthesis

CIGS Manufacturing Technology Landscape

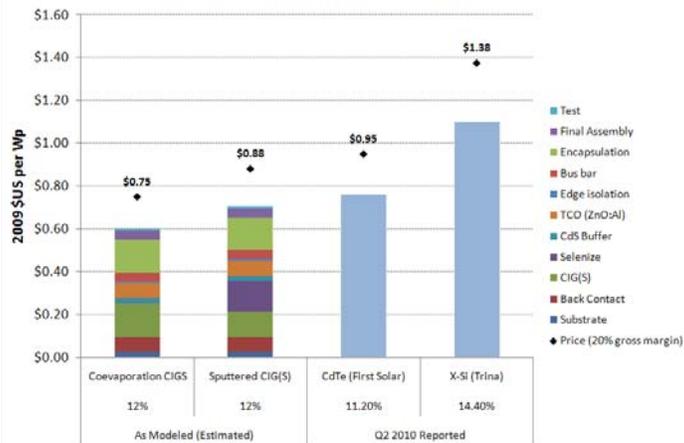
Best Commercially Available Module Efficiencies
Number of Commercial Companies



CIGS Manufacturing Costs

Solar PV Module Manufacturing Costs:

Benchmarking Analysis; CIGS v. CdTe, X-Si Incumbents

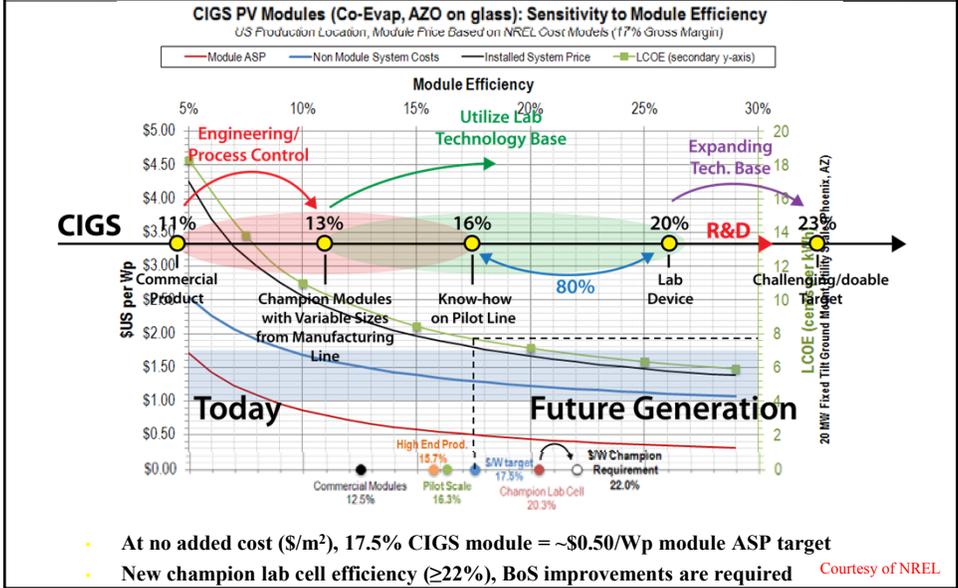


Module costs must be considered in the context of module efficiency (impact on installation costs)

Courtesy of NREL



The Value Proposition for High Efficiency CIGS

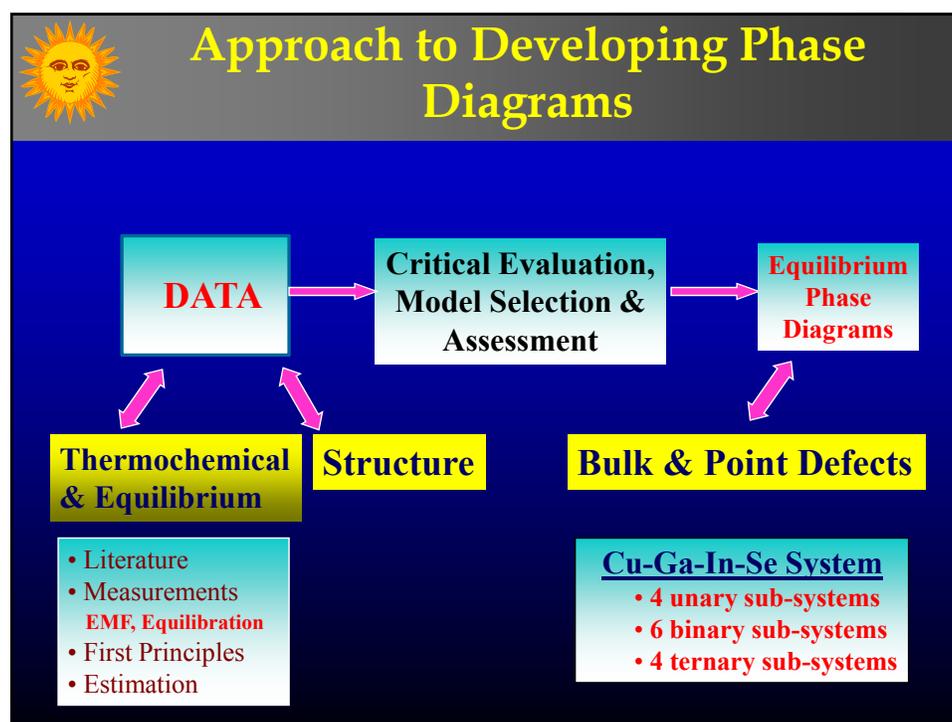
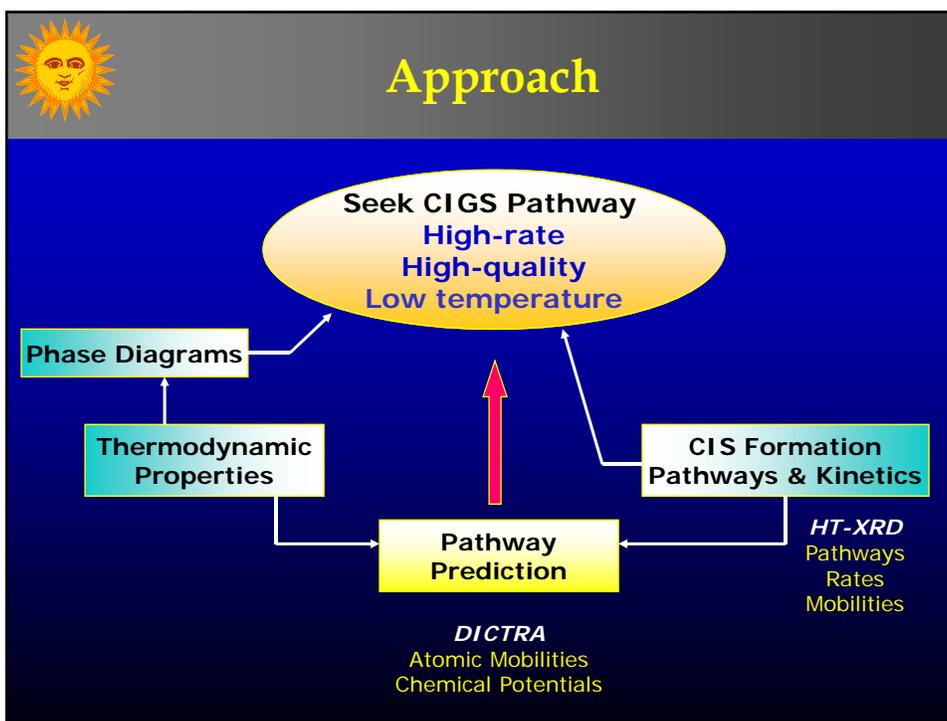


Future Challenges and Opportunities

Device structure varies between monolithically & mechanically integrated modules

Today	Front Contact Grid	Forward
<ul style="list-style-type: none"> ZnO, ITO (2500 Å) <ul style="list-style-type: none"> • Sputter CdS (700 Å) <ul style="list-style-type: none"> • Chemical Bath Deposition • Sputter CIGS (1-2.5 μm) <ul style="list-style-type: none"> • Multiple methods (coevaporation, sputtering, printing, electrodeposition) Mo (0.5-1 μm) <ul style="list-style-type: none"> • Sputter Glass, Metal Foil, Plastics 	<ul style="list-style-type: none"> • Screen Print Ag • Reduce shadowing • Faster application 	<ul style="list-style-type: none"> Hardened TCO (moisture barrier) Cd-free; dry, eliminate Increase Ga-%, Reduce thickness, Rapid deposition Uniformity (composition, temp., thickness) Na dosing High temp. glass Metal foils: smooth, flex-dielectric (monolith.)

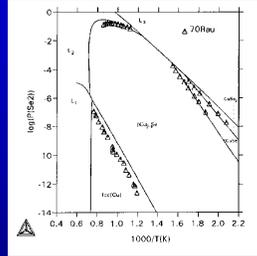
NREL National Renewable Energy Laboratory



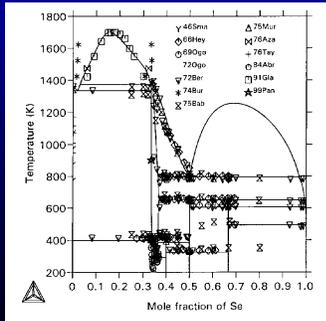


Comparison of Calculated Cu-Se Phase Diagram with Experimental Data

Phase	Model
Liquid	Ionic two sub-lattice model (Cu+1,Cu+2)p(Se-2,Va,Se)q
α -Cu _{2-x} Se	Sub-lattice model (3 sub-lattices) (Cu, Va) ₁ (Se, Va) ₁ (Cu) ₁
β -Cu _{2-x} Se	Sub-lattice model (3 sub-lattices) (Cu, Va) ₁ (Se, Va) ₁ (Cu) ₁
Fcc (Cu)	Regular solution model

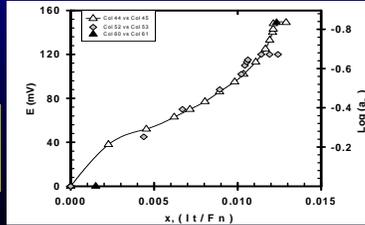


Se₂ Partial Pressure



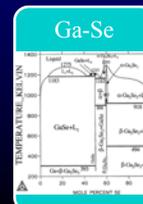
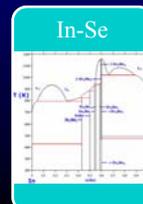
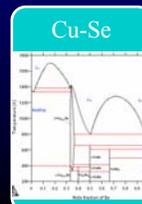
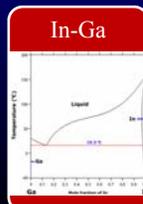
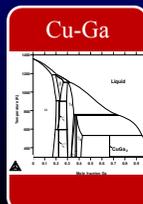
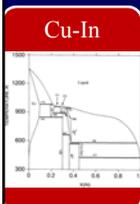
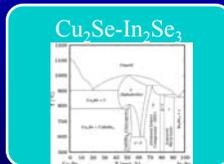
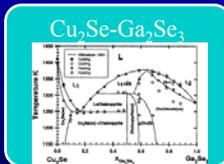
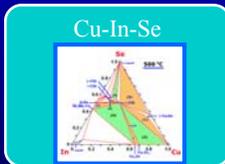
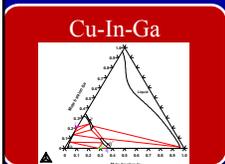
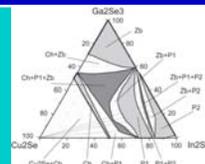
W/Cu,Cu₂O//YSZ//Cu_{2-x}Se, Cu₂O/C/W
 $[Cu] \leftrightarrow Cu_{[Cu_{2-x}Se]} \quad \ln a_{Cu} = -FE/RT$

V_{Cu} in Cu_{2-x}Se



Phase Equilibria in Cu-In-Ga-Se System

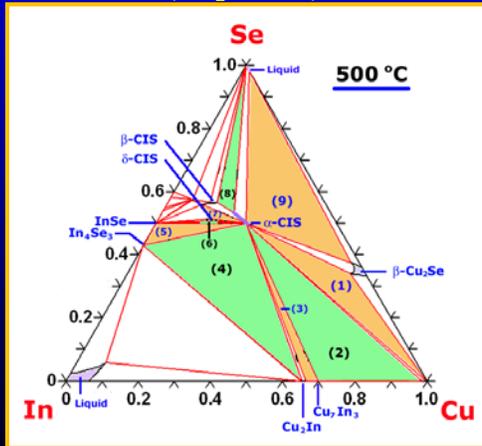
Cu-In-Ga-Se





Phase Diagram of Cu-In-Se

Isothermal section at 500 °C
(18 phases)

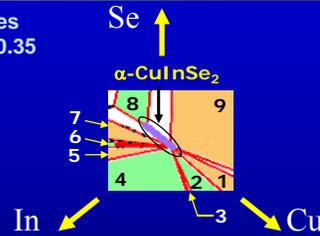
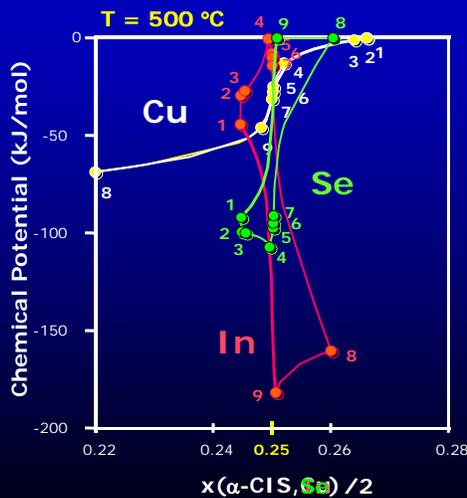


Region	Equilibrium phases
1	α -CuInSe ₂ + α -Cu + β -Cu ₂ Se
2	α -CuInSe ₂ + α -Cu + Cu ₇ In ₃
3	α -CuInSe ₂ + Cu ₂ In + Cu ₇ In ₃
4	α -CuInSe ₂ + Cu ₂ In + In ₄ Se ₃
5	α -CuInSe ₂ + InSe + In ₄ Se ₃
6	α -CuInSe ₂ + InSe + δ -CuInSe ₂
7	α -CuInSe ₂ + β -CuIn ₂ Se ₄ + δ -CuInSe ₂
8	α -CuInSe ₂ + β -CuIn ₂ Se ₄ + Liquid
9	α -CuInSe ₂ + β -Cu ₂ Se + Liquid



Chemical Potential Diagram

Wide molecular weight range yields 18 to >20% devices
Cu/(In+Ga): 0.95 to 0.82 and Ga/(In+Ga): 0.26 to 0.35

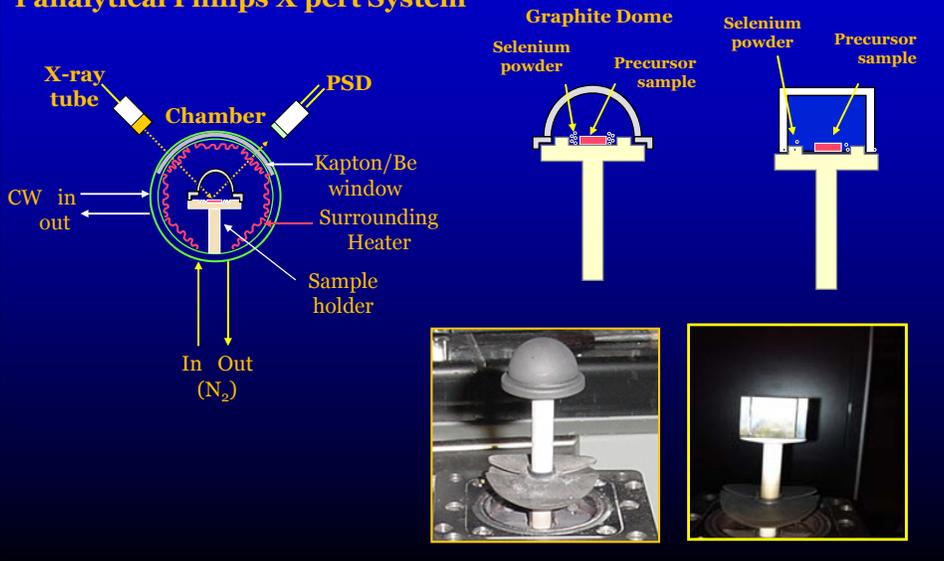


Reg.	Equilibrium phases
1	α -CuInSe ₂ + α -Cu + β -Cu ₂ Se
2	α -CuInSe ₂ + α -Cu + Cu ₇ In ₃
3	α -CuInSe ₂ + Cu ₂ In + Cu ₇ In ₃
4	α -CuInSe ₂ + Cu ₂ In + In ₄ Se ₃
5	α -CuInSe ₂ + InSe + In ₄ Se ₃
6	α -CuInSe ₂ + InSe + δ -CuInSe ₂
7	α -CuInSe ₂ + β -CuIn ₂ Se ₄ + δ -CuInSe ₂
8	α -CuInSe ₂ + β -CuIn ₂ Se ₄ + Liquid
9	α -CuInSe ₂ + β -Cu ₂ Se + Liquid

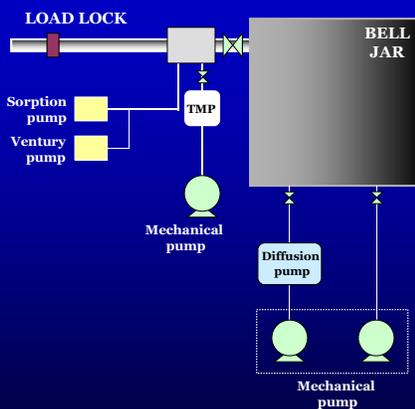


HT-XRD System

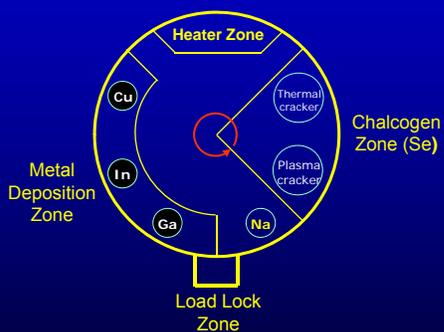
Panalytical Philips X'pert System



UF PMEE Reactor



Schematic top view of MEE reactor

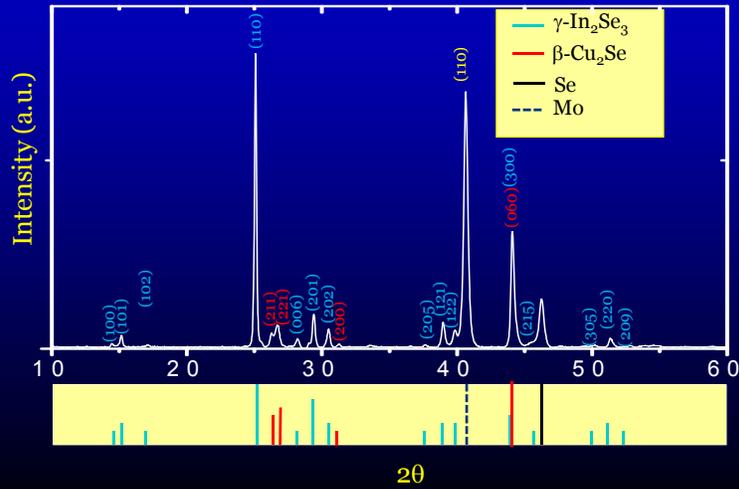


- Ultra high vacuum system
- Operating pressure : $\sim 10^{-8}$ Torr

- Rotating platen with 9 substrates (2x2 inches)
- Sequential deposition

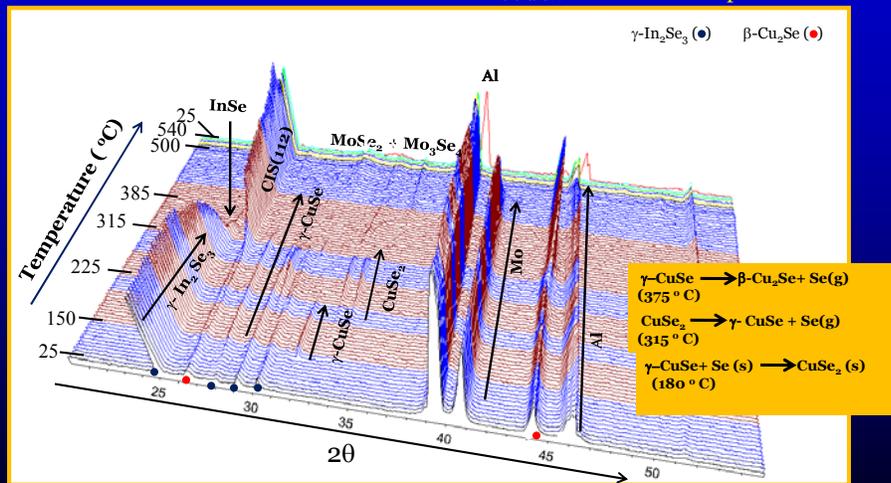


Glass/Mo/ γ -In₂Se₃/Cu₂Se: RTXRD



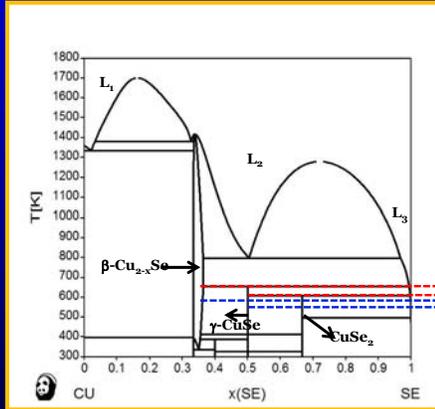
Glass/Mo/ γ -In₂Se₃/Cu₂Se/Se: Temperature Ramp Annealing

SS box Selenium Overpressure ~ 1 Torr

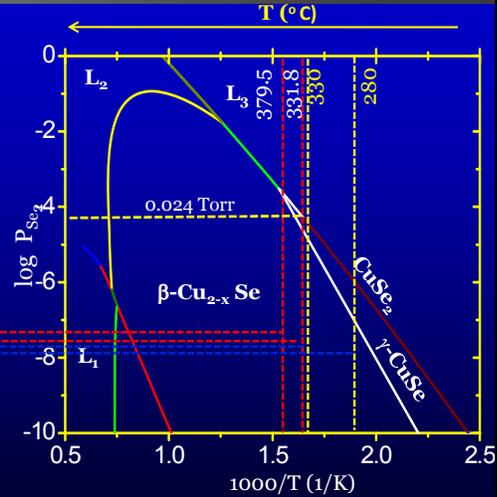




Cu-Se System Phase Equilibria



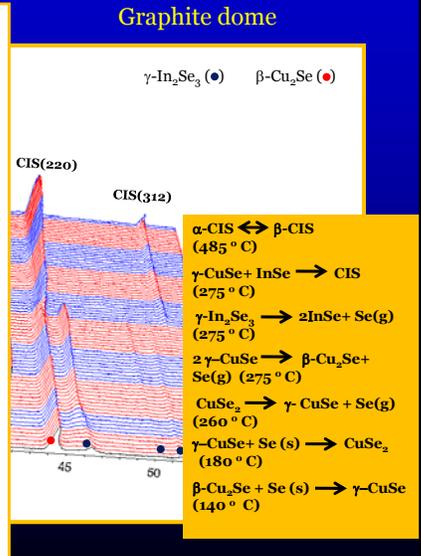
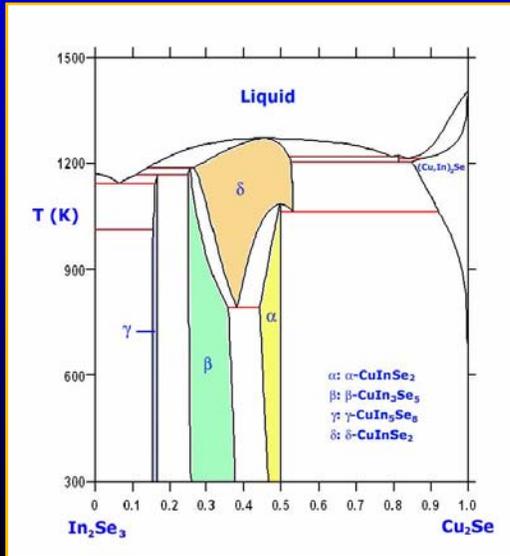
T-x Diagram



P-T Diagram

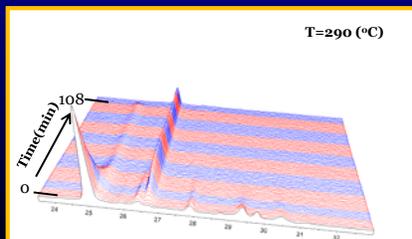
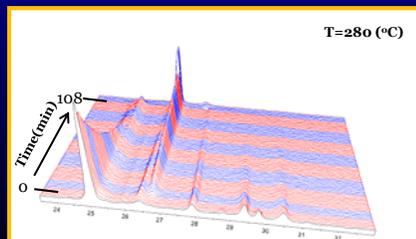
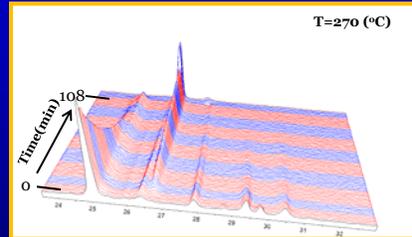
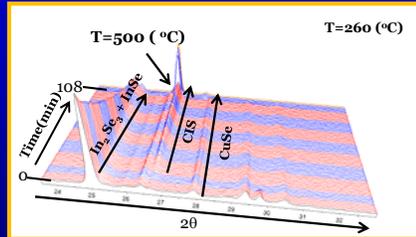


Glass/Mo/gamma-In2Se3/Cu2Se/Se: Temperature Ramp Annealing



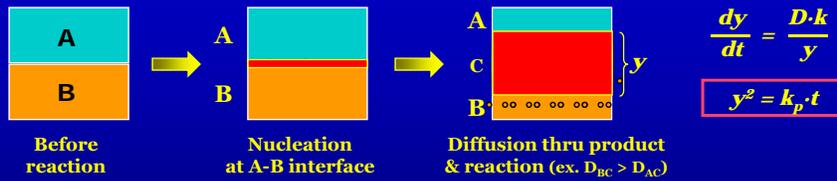


Isothermal Annealing Glass/Mo/ γ -In₂Se₃/Cu₂Se/Se

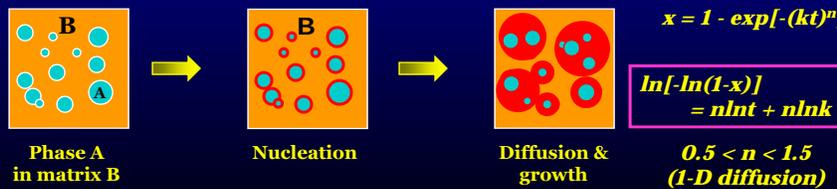


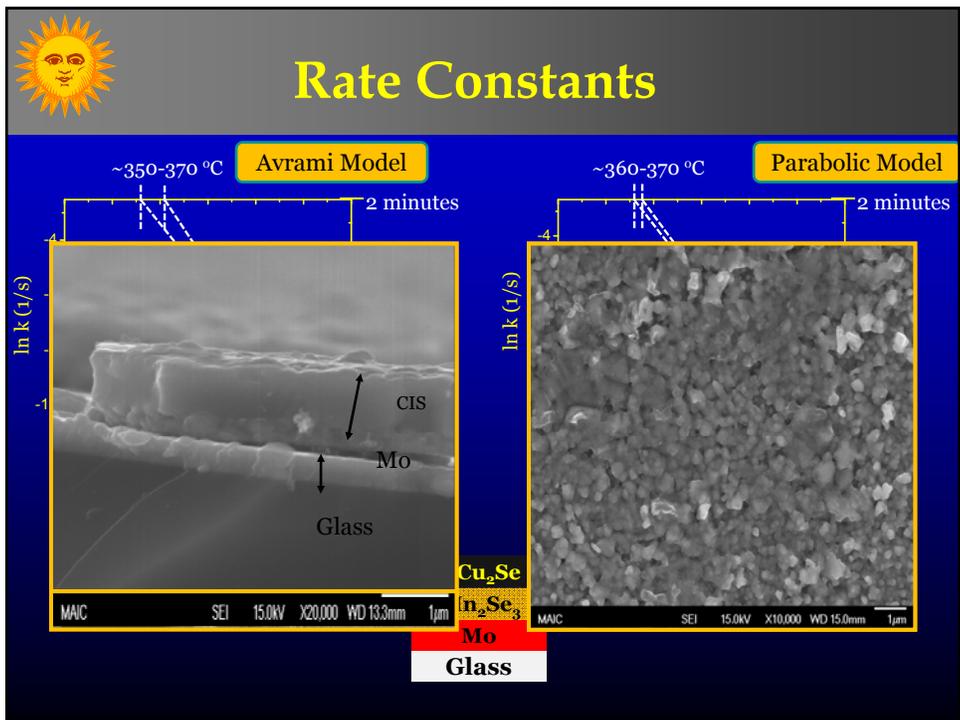
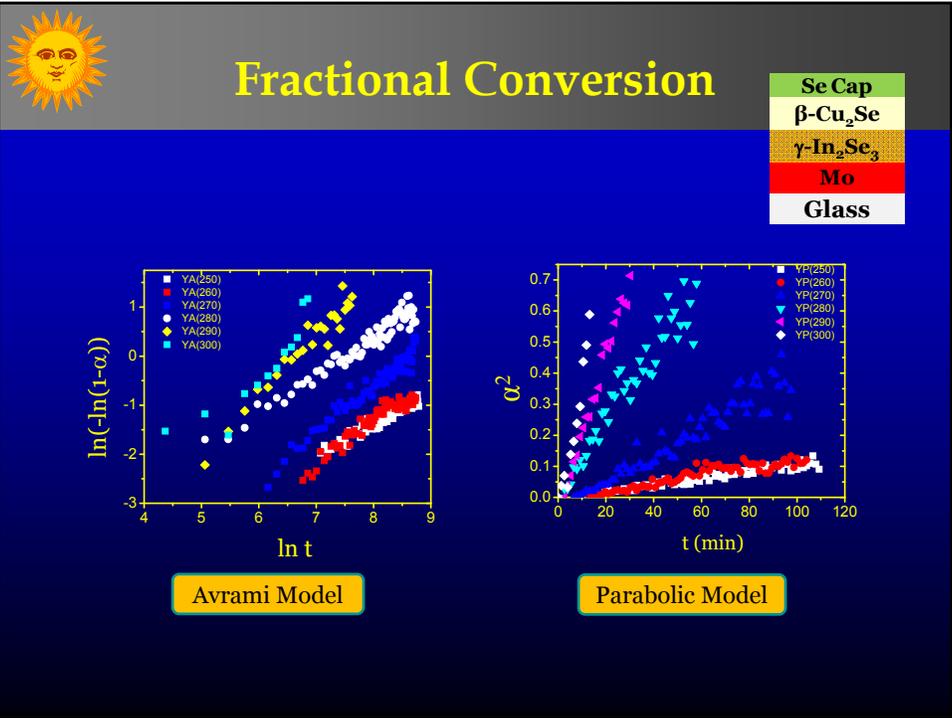
Solid-State Growth Models

• Parabolic growth model



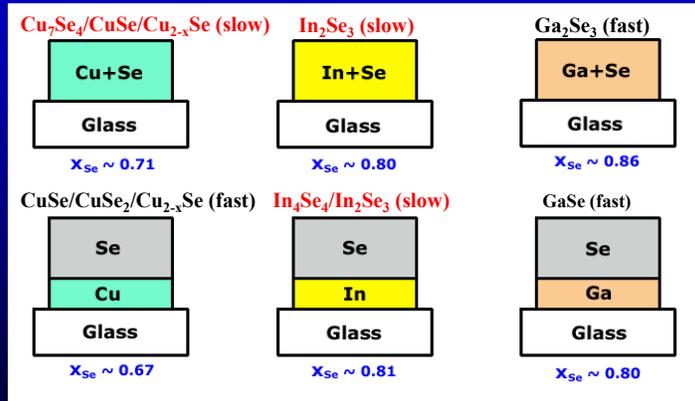
• Avrami growth model



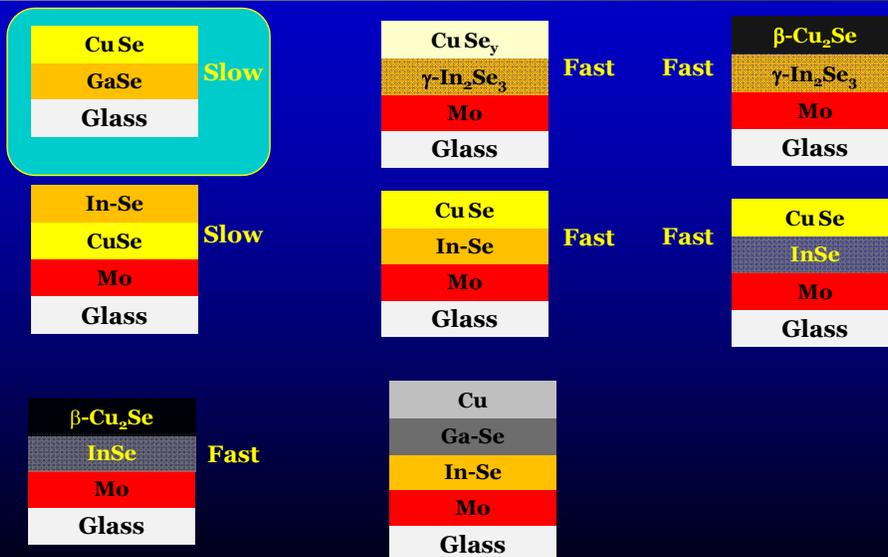




Pathways for Binary Precursor Structures

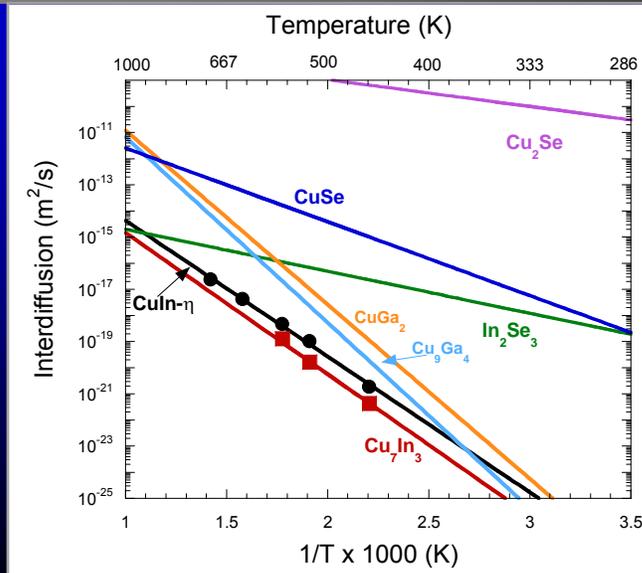


Bilayer Precursor Structures





Comparison of Interdiffusion in Various Intermetallics in Cu-In-Ga-Se



Metal Selenization Precursor Sets

Slow

Se (1 μm)
Ga (0.13 μm)
In (0.216 μm)
Cu (0.1 μm)
Mo (0.6 μm)
SS

Se (1 μm)
Cu (0.1 μm)
In (0.216 μm)
Ga (0.13 μm)
Mo (0.6 μm)
SS

Slow

Stacked Elemental Layer

Ga (5 nm)
In (70 nm)
Cu(30 nm)
Mo
Glass

} 3 times

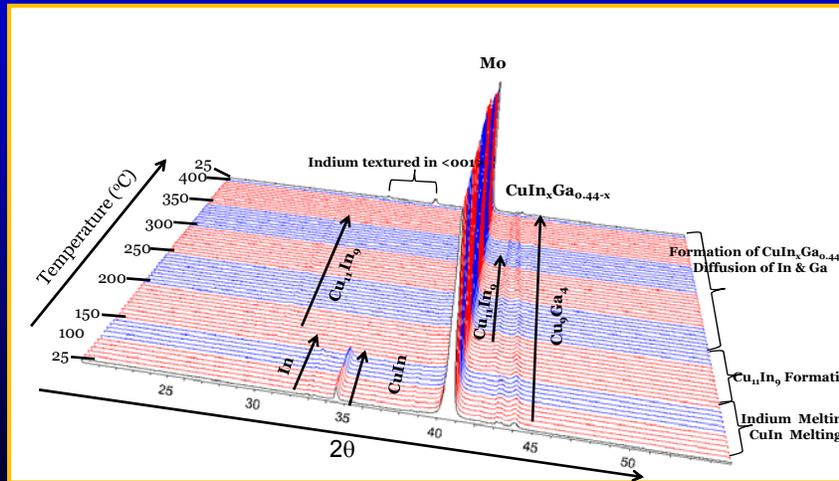
Ga (2 nm)
In (25 nm)
Cu(10 nm)
Mo
Glass

} 6 times

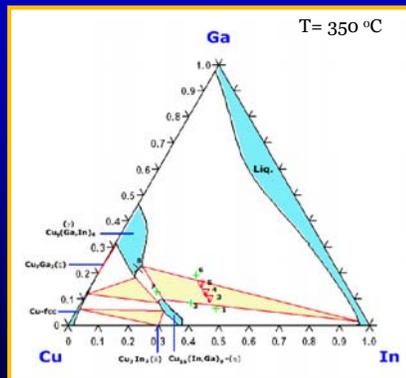
*Modulated Structure



Glass/Mo/CuIn/CuGa: Temperature Ramp Annealing



Cu-In-Ga Phase Diagram

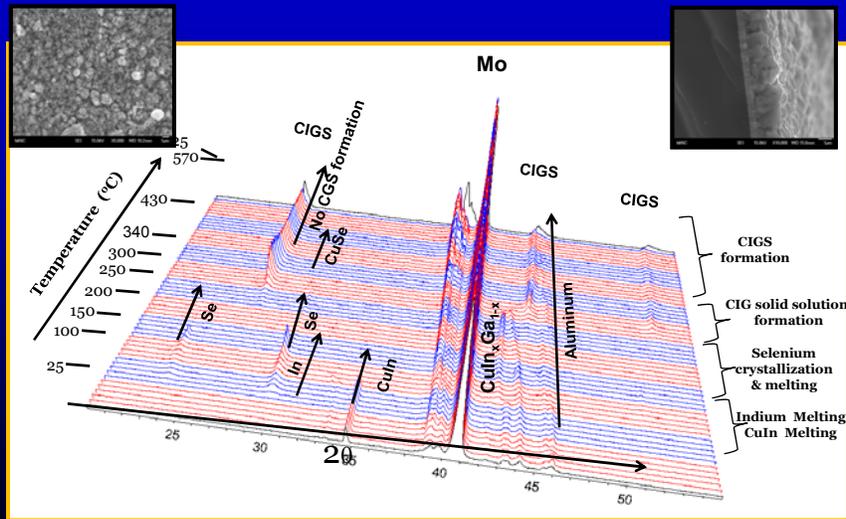


Phase Relationship at 350 ° C

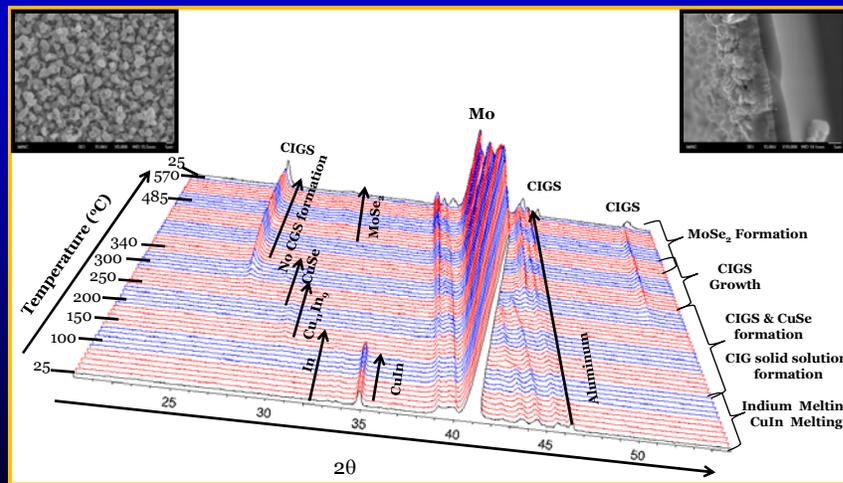
No	Atomic Fraction			Equilibrium phases
	Cu	In	Ga	
1	0.479	0.458	0.063	Cu ₁₀ (In,Ga) ₉ , In
2	0.550	0.365	0.086	Cu ₁₀ (In,Ga) ₉ , In
3	0.479	0.417	0.104	Cu ₁₀ (In,Ga) ₉ , In, Cu ₉ (In,Ga) ₄
4	0.479	0.391	0.130	Cu ₁₀ (In,Ga) ₉ , In, Cu ₉ (In,Ga) ₄
5	0.479	0.359	0.161	Cu ₁₀ (In,Ga) ₉ , In, Cu ₉ (In,Ga) ₄
6	0.479	0.328	0.193	In, Cu ₉ (In,Ga) ₄
7	0.640	0.230	0.129	Cu ₁₀ (In,Ga) ₉ , Cu ₉ (In,Ga) ₄
8	0.659	0.123	0.218	Cu ₉ (In,Ga) ₄



Glass/Mo/CuIn/CuGa/Se: Temperature Ramp Annealing

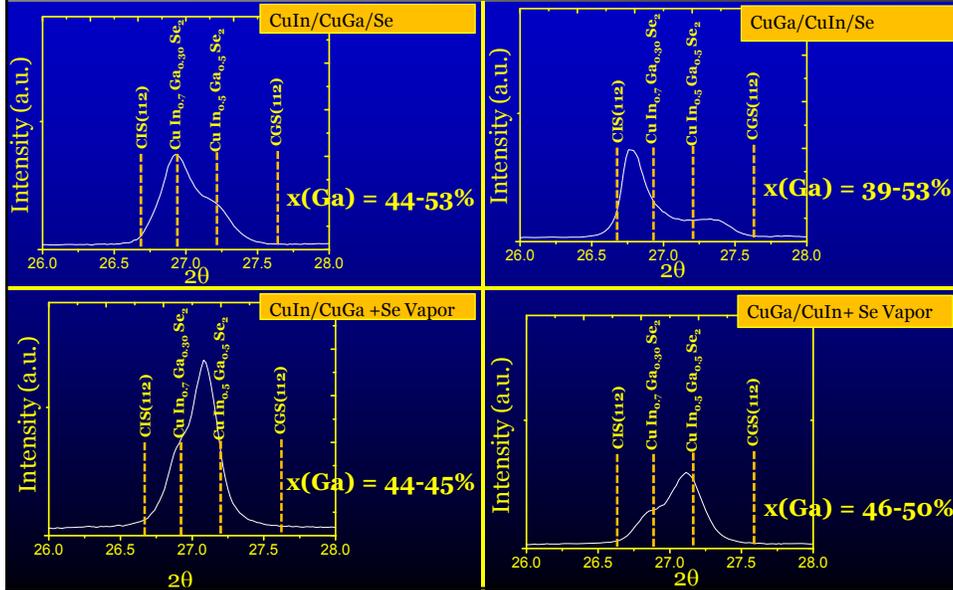


Temperature Ramp : Glass/Mo/CI/CG+ selenium vapor

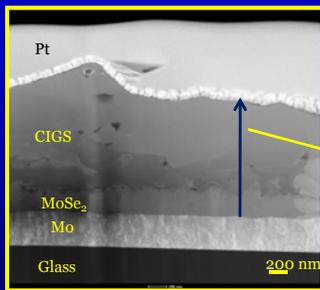




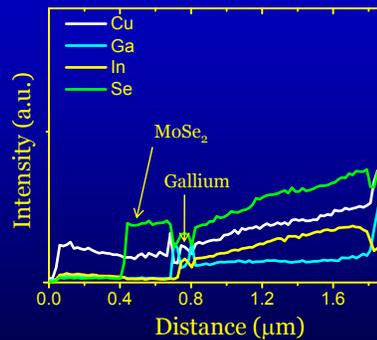
Ga Distribution



TEM-EDS



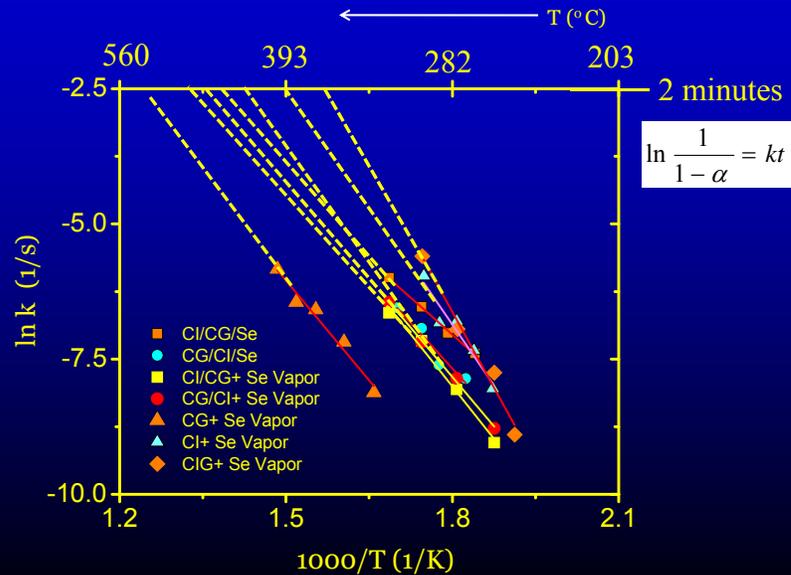
Dark Field Image



- ✓ MoSe₂ identified (300 nm) and same as previous sample (amorphous)
- Interface nature could not be determined
- ✓ Ga and In distributed non-uniformly across the thickness direction.
- ✓ More Ga towards the back contact.



Metal-Selenization Kinetics



Role of MoSe_2 in CIGS

- Literature suggests MoSe_2 - CIGS interfacial properties sensitive to processing conditions
- Modifies the contact resistance
 - Schottky contact without MoSe_2
 - Ohmic with but high resistance if MoSe_2 too thick or wrong orientation
- Influences adhesion characteristics
 - Poor adhesion without MoSe_2
 - Good adhesion depending on orientation

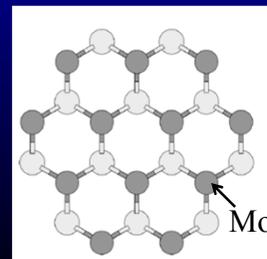
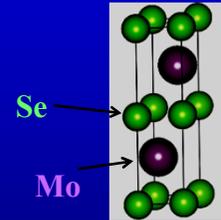
Need better understanding of growth habit

o P.E. Russell et al., "Properties of the Mo-CuInSe₂ interface", *Appl. Phys. Lett.* 40(11), 1984, pp. 995-997
o R. Wurz et al., "Formation of interfacial MoSe_2 layer in CVD grown CuGaSe₂ based thin film solar cells", *Thin solid films* 431-432, 2003, pp.398-402

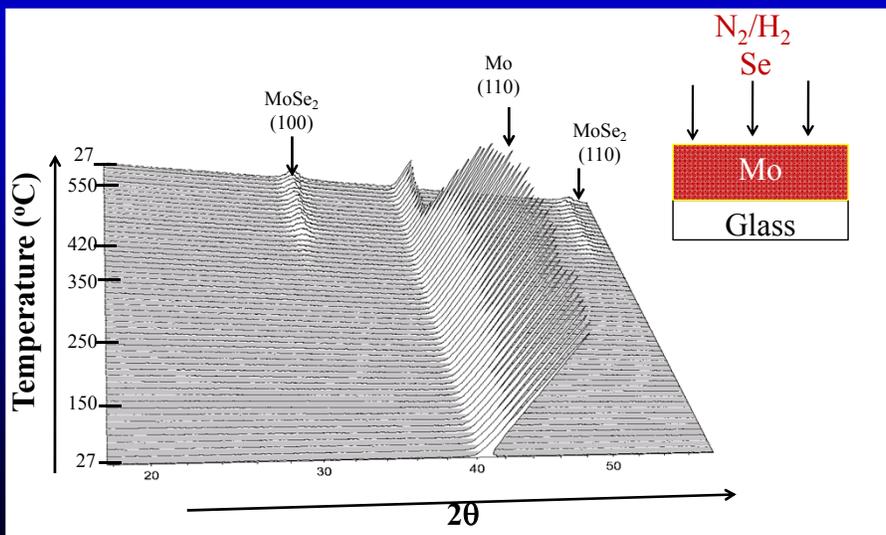


MoSe₂ Crystal Structure

- Hexagonal Crystal Structure
 - Lattice constants:
 $a = 3.28 \text{ \AA}$, $c = 12.9 \text{ \AA}$
- Strong Mo-Se covalent bonds in Se-Mo-Se layers
- Weak Van der Waals force between Se-Mo-Se layers

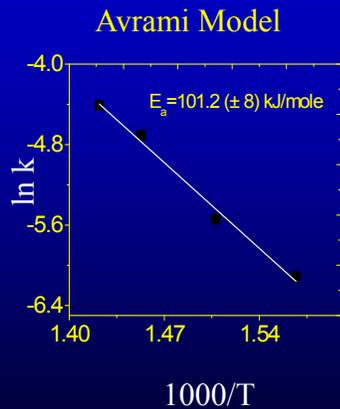


Temperature Ramp Selenization of Molybdenum in N₂/H₂ Atmosphere

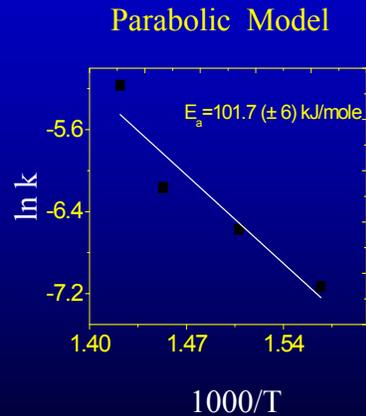




Kinetic Analysis



$$k = 4.08 \times 10^5 \exp(-101.2/RT)$$



$$k = 1.5 \times 10^5 \exp(-101.7/RT)$$



Conclusions

- Pathways are dependent on precursor structure
 - In phase particularly important
- Most paths are diffusion limited
- High-rate processes are possible
 - Film quality needs assessed
 - Liquid phase assisted growth
- Point defect chemistry helpful (low disordering energy)
 - Enhance diffusivity, defect compensation, type-inversion, impurity passivation

Comparison between a Chemical Processing Plant and an Integrated Circuit

	<i>TYPICAL CHEMICAL PLANT</i>	<i>TYPICAL INTEGRATED CIRCUIT</i>
Raw material source	Many but depleting	Electrical ground
Number of species	10^2 or more	2 (electron, hole)
Transport	Pipe (10 inch O.D.)	Wire, metal interconnect (10^{-5} inch O.D.)
Storage	Tank (10^6 moles)	Capacitor (10^{-10} moles)
Pump	10 hp	10^{-9} hp (bipolar transistor)
Control	Gate valve On-off valve Check valve	FET Transistor Diode
Reactions	Many	Recombination/generation
Flow Rates	10^3 moles/s	10^{-11} moles/s
Unit operations	$10^4/\text{mi}^2$	$10^{16}/\text{mi}^2$
Cost	$\$10^8$ ($\$10^9/\text{mi}^2$)	$\$10^2$ ($\$10^9/\text{mi}^2$)
Diffusion coefficient	10^{-2} to 10^{-5} cm^2/s	10 to 10^3 cm^2/s
Reaction Rate	10^6 1/moles/s	10^{16} 1/moles/s